



30V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(ON) MAX}	Package	I _D T _A = +25°C
30V	$40m\Omega @ V_{GS} = 10V$	SC59	5.1A
30 V	$50m\Omega$ @ $V_{GS} = 4.5V$	3039	4.3A

Description

This new generation MOSFET has been designed to minimize the onstate resistance ($R_{\text{DS(ON)}}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- Load Switch
- DC-DC Converters
- Power Management Functions

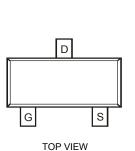
Features

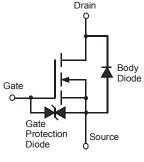
- Low On-Resistance
- FSD Protected Gate
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SC59
- Case Material Molded Plastic. UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Solderable per MIL-STD-202, Method 208 (e3)
- Terminal Connections: See Diagram
- Weight: 0.014 grams (approximate)
- •







Pin Configuration Equivalent Circuit

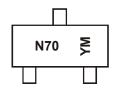
Ordering Information (Note 4)

Part Number	Case	Packaging
DMN3070SSN-7	SC59	3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http"//www.diodes.com/products/packages.html

Marking Information



N70 = Product Type Marking Code YM = Date Code Marking Y = Year ex: Z = 2012 M = Month ex: 9 = September

Date Code Key

1	Year	2010	2011	2012	2013	2014	2015	2016	2017
	i cui	2010	2011	2012	2010	2017	2010	2010	2017
	Code	X	Y	Z	Α	В	С	D	E

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Drain-Source Voltage			V_{DSS}	30	V
Gate-Source Voltage			V_{GSS}	±20	V
Continuous Drain Current (Note 6) V - 10V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	4.2 3.3	Α
Continuous Drain Current (Note 6) V _{GS} = 10V	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	l _D	5.1 4	Α
Continuous Drain Current (Note 6) V - 4.5V	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	3.7 2.8	Α	
Continuous Drain Current (Note 6) V _{GS} = 4.5V	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	4.3 3.3	Α
Pulsed Drain Current (10µs pulse, duty cycle = 1%)	I _{DM}	60	Α		
Maximum Body Diode Forward Current (Note 6)			Is	2	А

Thermal Characteristics

Characteristic		Symbol	Value	Units
Total Power Dissipation (Note 5)	T _A = +25°C	Pn	0.78	W
Total Power Dissipation (Note 5)	T _A = +70°C	PD	0.5	VV
Thermal Resistance, Junction to Ambient (Note 5)	Steady state	П	160	°C/W
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	$R_{\theta JA}$	115	°C/W
Total Power Dissipation (Note 6)	T _A = +25°C	Б	1.3	W
Total Fower Dissipation (Note 6)	T _A = +70°C	P_{D}	0.8	VV
Thermal Resistance, Junction to Ambient (Note 6)	Steady state	П	96	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	$R_{\theta JA}$	68	°C/W
Thermal Resistance, Junction to Case (Note 6)	$R_{\theta JC}$	18	°C/W	
Operating and Storage Temperature Range		$T_{J_i}T_{STG}$	-55 to +150	°C

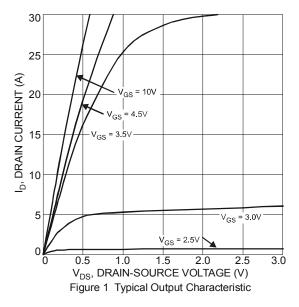
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

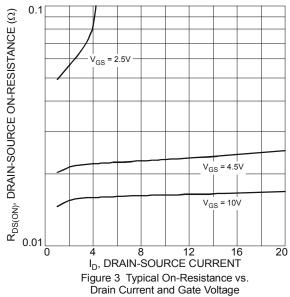
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)				I.		
Drain-Source Breakdown Voltage	BV _{DSS}	30	_	_	V	V _{GS} = 0V, I _D = 250μA
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μA	V _{DS} =24V, V _{GS} = 0V
Gate-Body Leakage	I _{GSS}	_	_	±10	μA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)			<u>. </u>			
Gate Threshold Voltage	V _{GS(th)}	1.1	_	2.1	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
Ot ii D. i. Oassaa Oa Baaistaa		_	24	40		V _{GS} = 10V, I _D = 4.2A
Static Drain-Source On-Resistance	R _{DS(ON)}	_	30	50	mΩ	V _{GS} = 4.5V, I _D = 2A
Forward Transfer Admittance	IY _{fs} I	_	2.7	_	S	V _{DS} = 5V, I _D =4.2A
Diode Forward Voltage	V _{SD}	_	0.75	1.0	V	V _{GS} = 0V, I _S = 1A
DYNAMIC CHARACTERISTICS (Note 8)			<u>, </u>		I	
Input Capacitance	C _{iss}	_	697	_	pF	
Output Capacitance	C _{oss}	_	97	_	pF	$V_{DS} = 15V, V_{GS} = 0V$
Reverse Transfer Capacitance	C _{rss}	_	67	_	pF	f = 1.0MHz
Gate Resistance	R _g	_	1.47	_	Ω	V _{DS} = 0V, V _{GS} = 0V, f = 1MHz
Total Gate Charge (V _{GS} = 4.5V)	Q_g	_	6	_		, == .
Total Gate Charge (V _{GS} = 10V)	Q_g	_	13.2	_	nC	V - 15V I 0A
Gate-Source Charge	Q_{gs}	_	2.2	_	110	$V_{DS} = 15V, I_D = 9A$
Gate-Drain Charge	Q_{gd}	_	1.8	_		
Turn-On Delay Time	t _{D(ON)}	_	4.3	_	ns	
Turn-Off Delay Time	t _{D(OFF)}		4.4	_	ns	V_{DD} =15V, V_{GEN} =10V, R_{GEN} =6 Ω ,
Turn-On Rise Time	t _r	_	20.1	_	ns	R _L =15Ω
Turn-Off Fall Time	t _f	_	4.1	_	ns	1
Reverse Recovery Time	t _{rr}	_	7.3	_	Ns	IF = 9A, di/dt = 500A/μs
Reverse Recovery Charge	Q _{rr}	_	7.9	_	nC	IF = 9A, di/dt = 500A/µs

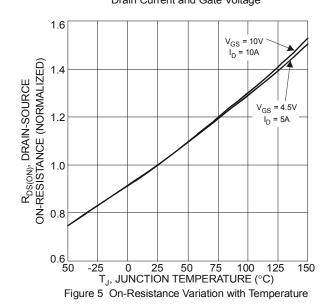
Notes: 5. Device mounted on FR-4 PCB with minimum recommended pad layout, single sided. The power dissipation P_D is based on t<10s R_{BJA}.

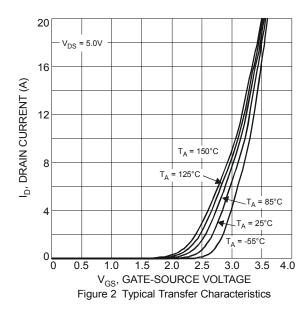
- 6. Device mounted on 1" \times 1" FR-4 PCB with high coverage 2 oz. Copper, single sided. The power dissipation PD is based on t<10s R_{BJA}.
- 7. Short duration pulse test used to minimize self-heating effect.
- 8. Guaranteed by design. Not subject to production testing.











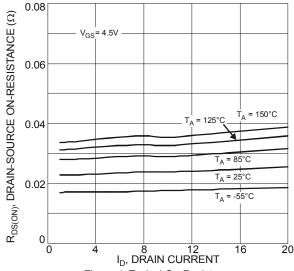
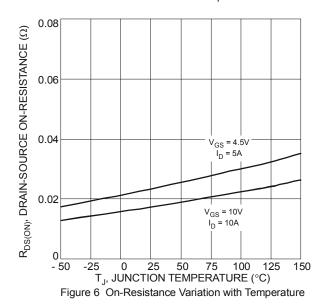


Figure 4 Typical On-Resistance vs. Drain Current and Temperature





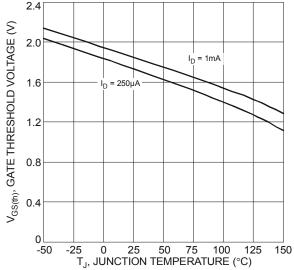


Figure 7 Gate Threshold Variation vs. Ambient Temperature

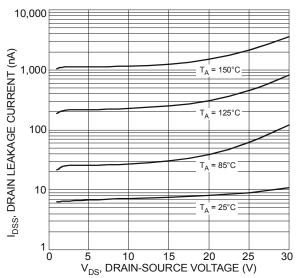
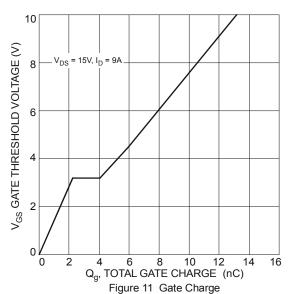
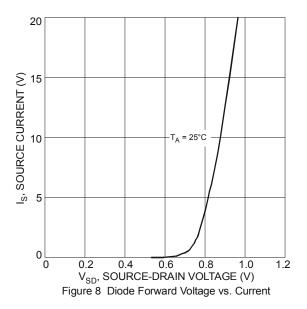
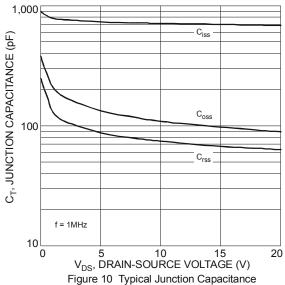


Figure 9 Typical Drain-Source Leakage Current vs. Voltage



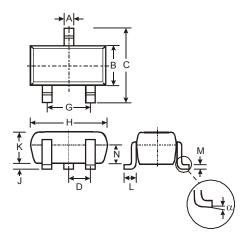






Package Outline Dimensions

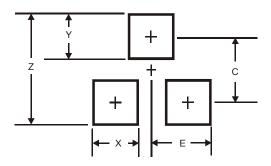
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



	SC59							
Dim	Min	Max	Тур					
Α	0.35	0.50	0.38					
В	1.50	1.70	1.60					
С	2.70	3.00	2.80					
D	-	-	0.95					
G	-	-	1.90					
Н	2.90	3.10	3.00					
J	0.013	0.10	0.05					
K	1.00	1.30	1.10					
L	0.35	0.55	0.40					
M	0.10	0.20	0.15					
N	0.70	0.80	0.75					
α	0°	8°	-					
All								

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	3.4
X	0.8
Υ	1.0
С	2.4
E	1.35



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